

L Number	Hits	Search Text	DB	Time stamp
-	320	glass near (substrate or board) and (vias or (through near holes)) and filler	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 15: 31
-	30	glass near (substrate or board) and (vias or (through near holes)) and filler and (display near device)	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 17: 19
-	49	361/760 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 15: 47
-	8	("4574255" "5502889" "5854534" "5953213" "6052287" "6137167" "6333857" "6362525").PN.	USPAT	2003/03/04 15: 47
-	23	361/748 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 06
-	2	5912654.URPN.	USPAT	2003/03/04 16: 11
-	13	361/750 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 14
-	11	361/751 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 15
-	18	361/761 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 20
-	7	361/765 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 23
-	14	361/767 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 24
-	6	361/768 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 35
-	11	361/772 and glass near (substrate or board) and (vias or (through near holes))	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/04 16: 36
-	219	glass near (substrate or board) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 11: 36
-	109	349/\$ and glass near (substrate or board) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 11: 01
-	48	359/\$ and glass near (substrate or board) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 11: 37

-	42	313/\$ and glass near (substrate or board) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 11: 53
-	1	"5739634".PN.	USPAT	2003/03/06 12: 00
-	4	5739634.URPN.	USPAT	2003/03/06 12: 02
-	0	6275254.URPN.	USPAT	2003/03/06 12: 13
-	5	("4164683" "4410830" "5541478" "5736814" "5739634").PN.	USPAT	2003/03/06 12: 13
-	13	4164683.URPN.	USPAT	2003/03/06 12: 14
-	4	5150005.URPN.	USPAT	2003/03/06 12: 15
-	9	5644327.URPN.	USPAT	2003/03/06 12: 36
-	4	(alkali near glass near (substrate or board)) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 12: 52
-	19	445/\$ and glass near (substrate or board) and (vias or (through near holes)) and (display near device) and driver	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/06 12: 59
-	4	5597518.URPN.	USPAT	2003/03/06 13: 03
-	34	4577133.URPN.	USPAT	2003/03/06 13: 06
-	26	levi near dameon	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/07 17: 00
-	1	gandhi near jay	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/07 17: 00
-	656	gandhi near jayprakash	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2003/03/07 17: 01